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September 2013

# NC7SZ66 Low Voltage Single SPST Normally Open Bus Switch

#### **Features**

- Broad V<sub>CC</sub> Operating Range: 1.65 V to 5.5 V
- Rail-to-Rail Signal Handling
- Power Down High-Impedance Inputs/Outputs
- 5 Ω Switch Connection between Two Ports
- Minimal Propagation Delay through the Switch
- Low I<sub>CC</sub>
- Zero Bounce in Flow-Through Mode
- Control Input Compatible with CMOS Input Levels
- Ultra-Small MicroPak™ Packages
- Space-Saving SOT23 and SC70 Packages

## **Description**

The NC7SZ66 is a ultra high-speed (UHS) CMOS compatible single-pole/single-throw (SPST) bus switch. The LOW on resistance of the switch allows inputs to be connected to outputs with minimal propagation delay and without generating additional ground bounce noise. The device is organized as a 1-bit switch with a switch enable (OE) signal. When OE is HIGH, the switch is on and port A is connected to port B. When OE is LOW, the switch is open and a high-impedance state exists between the two ports..

## **Ordering Information**

Part Number	Top Mark	Package	Packing Method
NC7SZ66M5X	7Z66	5-Lead SOT23, JEDEC MO-178 1.6 mm	3000 Units on Tape & Reel
NC7SZ66P5X	Z66	5-Lead SC70, EIAJ SC-88a, 1.25 mm Wide	3000 Units on Tape & Reel
NC7SZ66L6X	EE	6-Lead, MicroPak™, 1x1 mm Wide	5000 Units on Tape & Reel

## **Connection Diagrams**

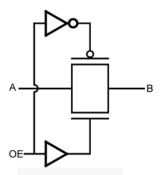


Figure 1. Logic Symbol

## **Pin Configurations**

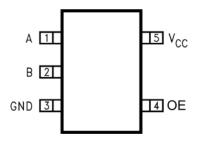


Figure 2. SC70 and SOT23 (Top View)

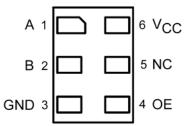


Figure 3. MicroPak™ (Top Through View)

## **Pin Definitions**

Pin # SC70 / SOT23	Pin # MicroPak™	Name	Description
1	1	A	Bus A I/O
2	2	В	Bus B I/O
3	3	GND	Ground
4	4	OE	Switch Enable Input
5	6	V <sub>CC</sub>	Supply Voltage
	5	NC	No Connect

## **Function Table**

OE	$B_0$	Function
L	High Z-State	Disconnected
Н	A <sub>0</sub>	Connect

H = HIGH Logic Level

L = LOW Logic Level

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parai	neter	Min.	Max.	Unit
V <sub>cc</sub>	Supply Voltage		-0.5	7.0	V
Vs	DC Switch Voltage <sup>(1)</sup>		-0.5	V <sub>CC</sub> to 0.5	V
$V_{IN}$	DC Input Voltage		-0.5	7.0	V
I <sub>IK</sub>	DC Input Diode Current	V <sub>IN</sub> < 0 V		-50	mA
I <sub>OUT</sub>	DC Output Sink Current			128	mA
I <sub>CC</sub> or I <sub>GND</sub>	DC V <sub>CC</sub> or Ground Current			±100	mA
T <sub>STG</sub>	Storage Temperature Range		-65	+150	°C
TJ	Junction Temperature Under Bia	S		+150	°C
TL	Junction Lead Temperature (Sol	dering, 10 Seconds)		+260	°C
D	Dower Discipation at 1959C	SOT-23		200	\A/
$P_{D}$	Power Dissipation at +85°C	SC70-5		150	mW
ECD	Human Body Model, JEDEC:JES	SD22-A114		4000	\/
ESD	Charge Device Model: JEDEC:J	ESD22-C101		1500	V

#### Note:

## **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Max.	Unit	
V <sub>CC</sub>	Supply Voltage Operating		1.65	5.50	V	
$V_{IN}$	Input Voltage		0	5.5	V	
Vs	Switch Input Voltage		0	V <sub>CC</sub>	V	
V <sub>OUT</sub>	Output Voltage		0	V <sub>CC</sub>	V	
		V <sub>CC</sub> =2.3 V - 3.6 V	0	10		
$t_r, t_f$	Input Rise and Fall Times	V <sub>CC</sub> =4.5 V - 5.5 V	0	5	ns/V	
		Switching I/O	0	DC		
T <sub>A</sub>	Operating Temperature		-40	+85	°C	
0	Thermal Desistance	SOT-23		300	0000	
$ heta_{JA}$	Thermal Resistance	SC70-5		425	°C/W	

#### Note:

2. Unused inputs must be held HIGH or LOW; they may not float.

The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

## **DC Electrical Characteristics**

All typical values are at the specified  $V_{CC}$ , and  $T_A = 25^{\circ}C$ .

0	D	.,	0 1111	T <sub>A</sub> =-40 to +85°C T <sub>A</sub> =+25		25°C	11		
Symbol	I Parameter V <sub>cc</sub>		Conditions	Min.	Тур.	Max.	Min.	Тур.	Units
	HIGH Level	1.65 to 1.95		0.75 V <sub>CC</sub>					.,
V <sub>IH</sub>	Input Voltage	2.30 to 5.50		0.7 V <sub>CC</sub>					V
V <sub>IL</sub>	LOW Level	1.65 to 1.95				0.25 V <sub>CC</sub>			\ \ \
VIL	Input Voltage	2.30 to 5.50				0.3 V <sub>CC</sub>			V
I <sub>IN</sub>	Control Input Leakage Current	0 to 5.5	$0 \le V_{IN} \le 5.5 \text{ V}$		±0.05	±1.00			μA
l <sub>OFF</sub>	Off Leakage Current	1.65 to 5.50	0 ≤ A, B ≤ V <sub>CC</sub>		±0.05	±10.00			μA
			$V_{IN}$ =0 V, $I_{IN}$ =30 mA		3	7			
		4.5	$V_{IN}$ =2.4 V, $I_{IN}$ =15 mA		5	12			
			V <sub>IN</sub> =4.5 V, I <sub>IN</sub> =30 mA		7	15			
	Outliet On	3.0	V <sub>IN</sub> =0 V, I <sub>IN</sub> =24 mA		4	9			
R <sub>ON</sub>	Switch On Resistance <sup>(3)</sup>	3.0	V <sub>IN</sub> =3 V, I <sub>IN</sub> =24 mA		10	20			Ω
		2.30	V <sub>IN</sub> =0 V, I <sub>IN</sub> =8 mA		5	12			
		2.50	$V_{IN}$ =2.3 V, $I_{IN}$ =8 mA		13	30			
		1.8	V <sub>IN</sub> =0 V, I <sub>IN</sub> =4 mA		7	28			
4		1.0	V <sub>IN</sub> =1.8 V, I <sub>IN</sub> =4 mA		25	60			
		5.0	$I_A$ =-30 mA, $0 \le V_{Bn} \le V_{CC}$					6	
D	On Resistance	3.3	$I_A = -24 \text{ mA},$ $0 \le V_{Bn} \le V_{CC}$					12	
R <sub>flat</sub>	Flatness (3,4,5)	2.5	$I_{A}\text{=-8mA}, \\ 0 \le V_{Bn} \le V_{CC}$					28	Ω
		1.8	$I_{A}\text{=-4 mA}, \\ 0 \leq V_{Bn} \leq V_{CC}$					125	
I <sub>cc</sub>	Quiescent Supply Current	1.65 to 5.50	$V_{IN}=V_{CC}$ or GND, $I_{OUT}=0$		0.05	10.00			μA

#### Notes:

- 3. Measured by the voltage drop between pins A and B at the indicated current through the switch. On resistance is determined by the lower of the voltages on the two (A or B) pins.
- 4. Parameter is characterized but not tested in production.
- 5. Flatness is defined as the difference between the maximum and minimum value of on resistance over the specified range of conditions.

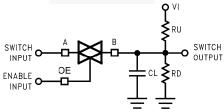
#### **AC Electrical Characteristics**

All typical values are at the specified  $V_{CC}$ , and  $T_A = 25^{\circ}C$ .

Symbol	Parameter	V <sub>cc</sub>	$\begin{array}{c c} & T_{\text{A}}\text{=-40 to +85}^{\circ}\text{C}, \\ & C_{\text{L}}\text{=50Pf}. \\ & \text{RU=RD=500 }\Omega \end{array} \text{ Units}$		C <sub>L</sub> =50Pf.		Units	Figure
				Min.	Тур.	Max.		
		1.65 to 1.95				4.3		
	Propagation Delay	2.3 to 2.7	V <sub>IN</sub> =0PEN			1.2	20	Figure 5
t <sub>PHL</sub> , t <sub>PLH</sub>	Bus-to-Bus <sup>(6)</sup>	3.0 to 3.6	VINEUPEIN			0.8	ns	Figure 6
		4.5 to 5.5				0.3		
		1.65 to 1.95		1.5	7.0	14.2		
	Output Enable Time	2.3 to 2.7	$V_{IN}=2 \times V_{CC}$ for $t_{PZL}$ ,	1.5	3.3	7.0		Figure 5
$t_{PZL}, t_{PZH}$	Output Enable Time	3.0 to 3.6	V <sub>IN</sub> =0 V for t <sub>PZH</sub>	1.5	2.4	5.5	ns	Figure 6
		4.5 to 5.5		1.5	2.0	4.5		
	/	1.65 to 1.95		1.5	9.2	18.2		
	Output Diochlo Timo	2.3 to 2.7	$V_{IN}=2 \times V_{CC}$ for $t_{PLZ}$ ,	1.5	5.3	9.0	200	Figure 5
$t_{PLZ}, t_{PHZ}$	Output Disable Time	3.0 to 3.6	V <sub>IN</sub> =0 V for t <sub>PHZ</sub>	1.5	4.0	7.0	ns	Figure 6
		4.5 to 5.5		1.5	2.7	5.0		
C <sub>IN</sub>	Control Pin Input Capacitance		V <sub>CC</sub> =0		2		pF	
C <sub>I/O</sub>	Input / Output Capacitance		V <sub>CC</sub> =05.0 V		6		pF	

#### Note:

6. This parameter is guaranteed by design but is not tested. The switch contributes no propagation delay other than the RC delay of the typical on resistance of the switch and the 50pF load capacitance, when driven by an ideal voltage source (zero output impedance).



#### Notes:

- 7. Input driven by 50  $\Omega$ ; source terminated in 50  $\Omega$ .
- 8. C<sub>L</sub> includes load and stray capacitance.
- 9. Input PRR=1.0 MHz;  $t_w$ =500 ns.

Figure 4. AC Test Circuit

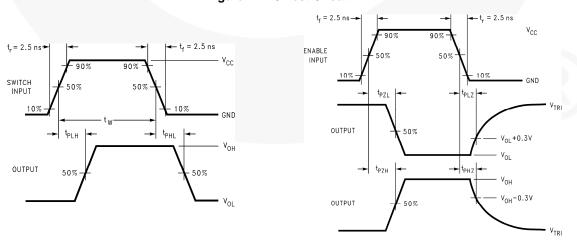


Figure 5. AC Waveforms

## **Physical Dimensions**

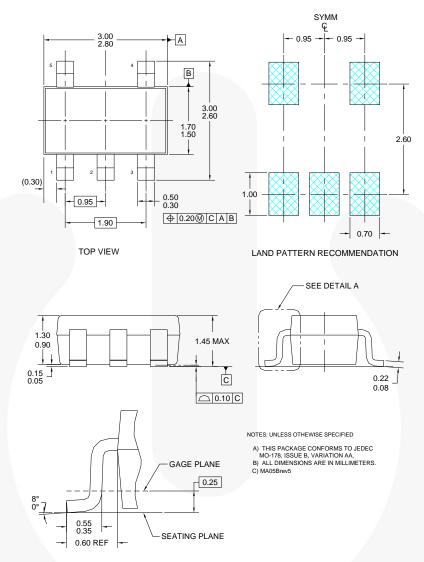


Figure 6. 5-Lead SOT23, JEDEC MO-178 1.6 mm

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Package Designator	Tape Section	<b>Cavity Number</b>	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
M5X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

## **Physical Dimensions**

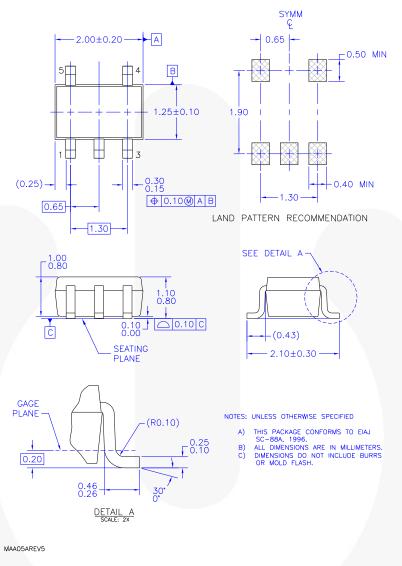


Figure 7. 5-Lead, SC70, EIAJ SC-88a, 1.25 mm Wide

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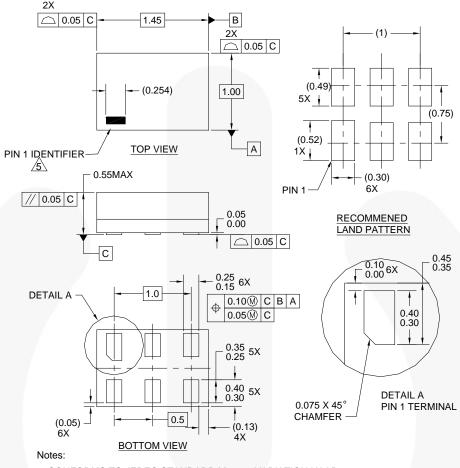
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Package Designator	Tape Section	<b>Cavity Number</b>	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
P5X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

## **Physical Dimensions**



- 1. CONFORMS TO JEDEC STANDARD M0-252 VARIATION UAAD
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994
- 4. FILENAME AND REVISION: MAC06AREV4
- 5. PIN ONE IDENTIFIER IS 2X LENGTH OF ANY

OTHER LINE IN THE MARK CODE LAYOUT.

Figure 8. 6-Lead, MicroPak™, 1.0 mm Wide

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Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
L6X	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed





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